

General Description

These N-channel MOSFET are produced using advanced MagnaChip's MOSFET Technology, which provides low on-state resistance, high switching performance and excellent quality.

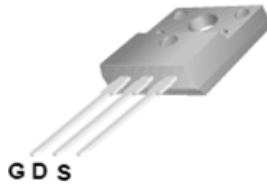
These devices are suitable device for SMPS, high Speed switching and general purpose applications.

Features

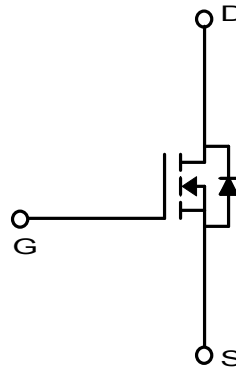
- $V_{DS} = 600V$
- $I_D = 10A$ @ $V_{GS} = 10V$
- $R_{DS(ON)} \leq 0.75\Omega$ @ $V_{GS} = 10V$

Applications

- Power Supply
- PFC
- High Current, High Speed Switching



**TO-220FS
MDFS Series**



Absolute Maximum Ratings (Ta = 25°C)

| Characteristics | Symbol | Rating | Unit | |
|--|----------------|--------------------|-------|------|
| Drain-Source Voltage | V_{DSS} | 600 | V | |
| Gate-Source Voltage | V_{GSS} | ±30 | V | |
| Continuous Drain Current | I_D | $T_C=25^\circ C$ | 10.0* | A |
| | | $T_C=100^\circ C$ | 6.33* | A |
| Pulsed Drain Current ⁽¹⁾ | I_{DM} | 40* | A | |
| Power Dissipation | P_D | $T_C=25^\circ C$ | 48.6 | W |
| | | Derate above 25 °C | 0.39 | W/°C |
| Repetitive Avalanche Energy ⁽¹⁾ | E_{AR} | 4.86 | mJ | |
| Peak Diode Recovery dv/dt ⁽³⁾ | dv/dt | 4.5 | V/ns | |
| Single Pulse Avalanche Energy ⁽⁴⁾ | E_{AS} | 580 | mJ | |
| Junction and Storage Temperature Range | T_J, T_{stg} | -55~150 | °C | |

* Id limited by maximum junction temperature

Thermal Characteristics

| Characteristics | Symbol | Rating | Unit |
|--|-----------------|--------|------|
| Thermal Resistance, Junction-to-Ambient ⁽¹⁾ | $R_{\theta JA}$ | 62.5 | °C/W |
| Thermal Resistance, Junction-to-Case ⁽¹⁾ | $R_{\theta JC}$ | 2.57 | |

Ordering Information

| Part Number | Temp. Range | Package | Packing | RoHS Status |
|--------------|-------------|----------|---------|--------------|
| MDFS10N60DTH | -55~150°C | TO-220FS | Tube | Halogen Free |

Electrical Characteristics (Ta =25°C)

| Characteristics | Symbol | Test Condition | Min | Typ | Max | Unit |
|--|--------------|--|-----|------|------|----------|
| Static Characteristics | | | | | | |
| Drain-Source Breakdown Voltage | BV_{DSS} | $I_D = 250\mu A, V_{GS} = 0V$ | 600 | - | - | V |
| Gate Threshold Voltage | $V_{GS(th)}$ | $V_{DS} = V_{GS}, I_D = 250\mu A$ | 2.0 | - | 4.0 | |
| Drain Cut-Off Current | I_{DSS} | $V_{DS} = 600V, V_{GS} = 0V$ | - | - | 1 | μA |
| Gate Leakage Current | I_{GSS} | $V_{GS} = \pm 30V, V_{DS} = 0V$ | - | - | 100 | nA |
| Drain-Source ON Resistance | $R_{DS(ON)}$ | $V_{GS} = 10V, I_D = 5.0A$ | - | 0.62 | 0.75 | Ω |
| Forward Transconductance | g_{fs} | $V_{DS} = 30V, I_D = 5.0A$ | - | 13 | - | S |
| Dynamic Characteristics | | | | | | |
| Total Gate Charge | Q_g | $V_{DS} = 480V, I_D = 10A, V_{GS} = 10V^{(2)}$ | - | 42.9 | - | nC |
| Gate-Source Charge | Q_{gs} | | - | 7.7 | - | |
| Gate-Drain Charge | Q_{gd} | | - | 18.7 | - | |
| Input Capacitance | C_{iss} | $V_{DS} = 25V, V_{GS} = 0V, f = 1.0MHz$ | - | 1595 | - | pF |
| Reverse Transfer Capacitance | C_{riss} | | - | 20 | - | |
| Output Capacitance | C_{oss} | | - | 168 | - | |
| Turn-On Delay Time | $t_{d(on)}$ | $V_{GS} = 10V, V_{DS} = 300V, I_D = 10A^{(2)}, R_G = 25\Omega$ | - | 22 | - | ns |
| Rise Time | t_r | | - | 26 | - | |
| Turn-Off Delay Time | $t_{d(off)}$ | | - | 160 | - | |
| Fall Time | t_f | | - | 43.5 | - | |
| Drain-Source Body Diode Characteristics | | | | | | |
| Maximum Continuous Drain to Source Diode Forward Current | I_S | | - | - | 10 | A |
| Source-Drain Diode Forward Voltage | V_{SD} | $I_S = 10A, V_{GS} = 0V$ | - | - | 1.4 | V |
| Body Diode Reverse Recovery Time | t_{rr} | $I_F = 10A, di/dt = 100A/\mu s^{(3)}$ | - | 319 | - | ns |
| Body Diode Reverse Recovery Charge | Q_{rr} | | - | 2.65 | - | μC |

Note :

- Pulse width is based on $R_{\theta JC}$ & $R_{\theta JA}$ and the maximum allowed junction temperature of 150°C.
- Pulse test: pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$, pulse width limited by junction temperature $T_{J(MAX)} = 150^\circ C$.
- $I_{SD} \leq 10.0A$, $di/dt \leq 200A/\mu s$, $V_{DD} \leq BV_{DSS}$, Starting $T_J = 25^\circ C$
- $L = 10.7mH$, $I_{AS} = 10.0A$, $V_{DD} = 50V$, $R_g = 25\Omega$, Starting $T_J = 25^\circ C$,

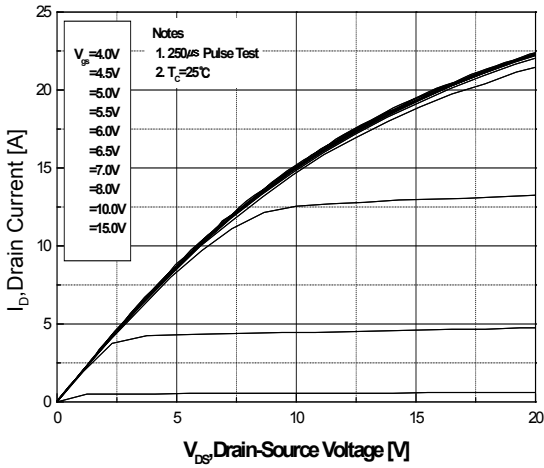


Fig.1 On-Region Characteristics

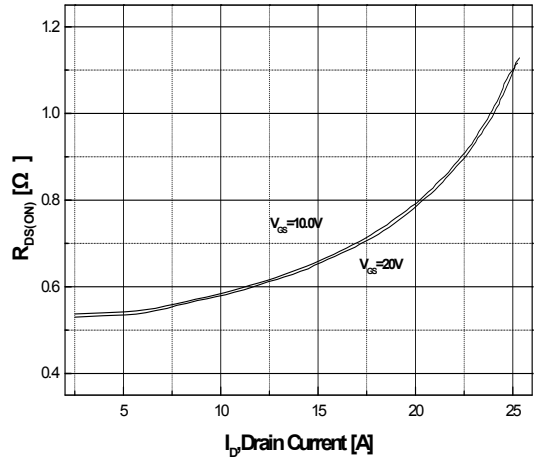


Fig.2 On-Resistance Variation with Drain Current and Gate Voltage

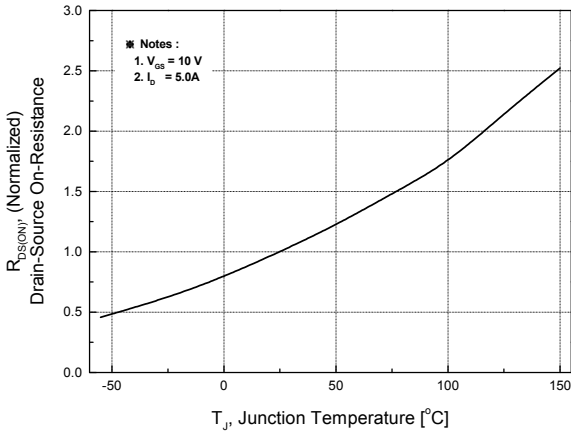


Fig.3 On-Resistance Variation with Temperature

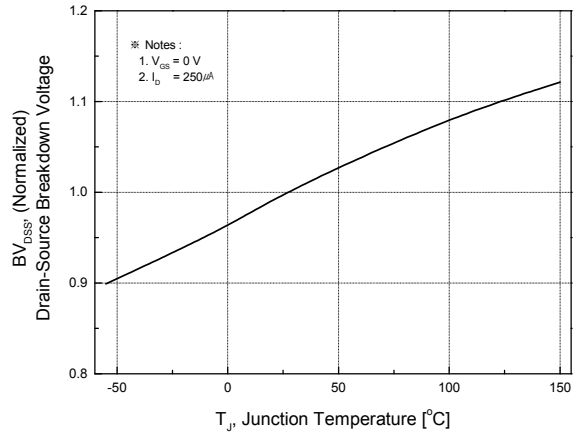


Fig.4 Breakdown Voltage Variation vs. Temperature

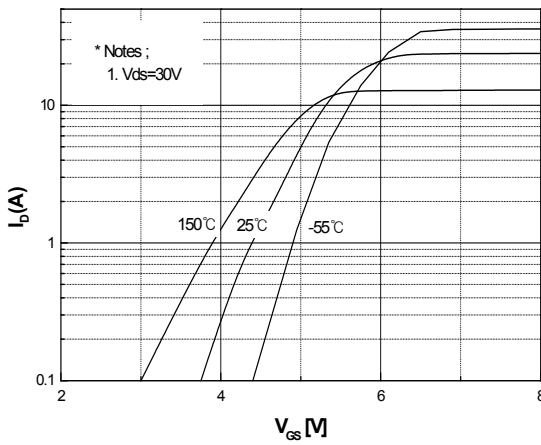


Fig.5 Transfer Characteristics

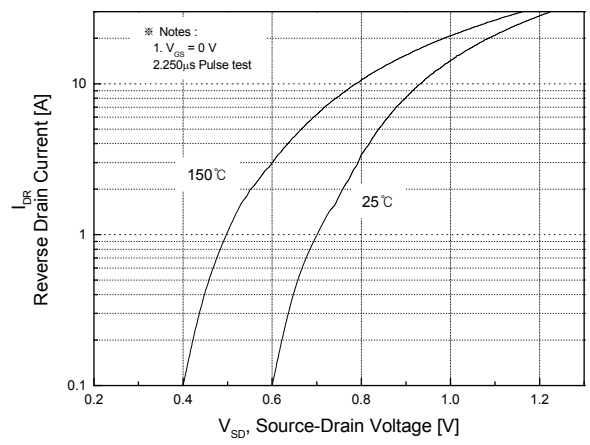


Fig.6 Body Diode Forward Voltage Variation with Source Current and Temperature

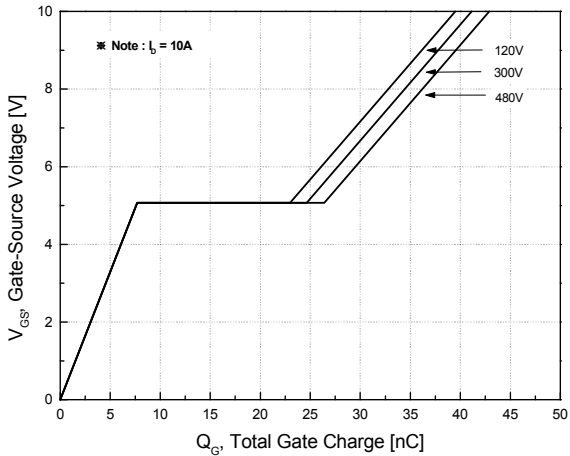


Fig.7 Gate Charge Characteristics

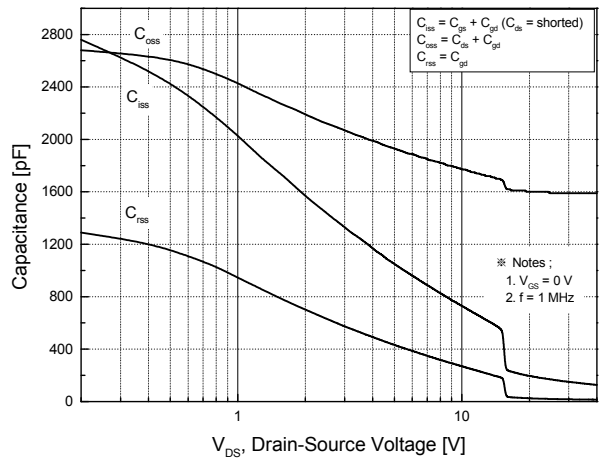


Fig.8 Capacitance Characteristics

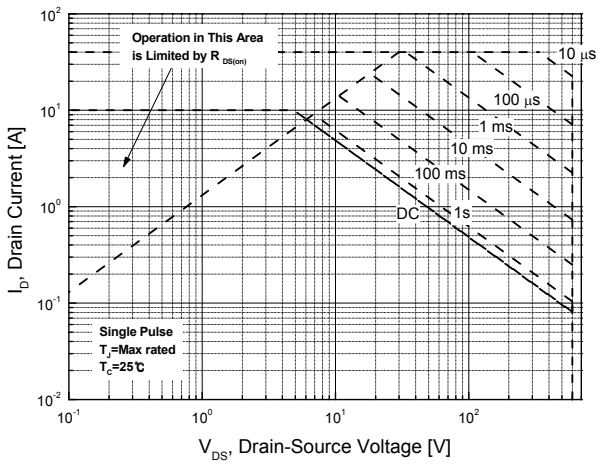


Fig.9 Maximum Safe Operating Area

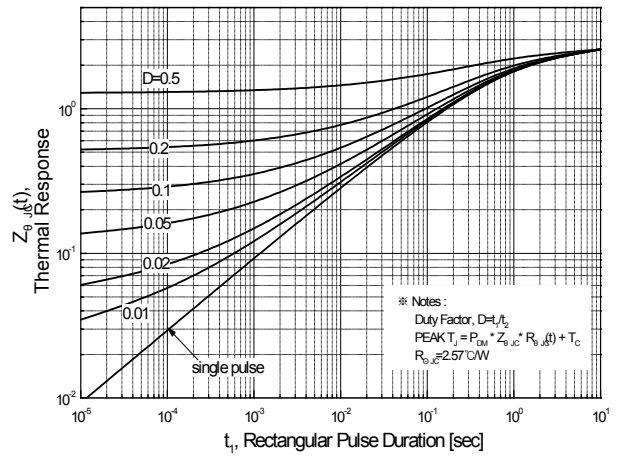


Fig.10 Transient Thermal Response Curve

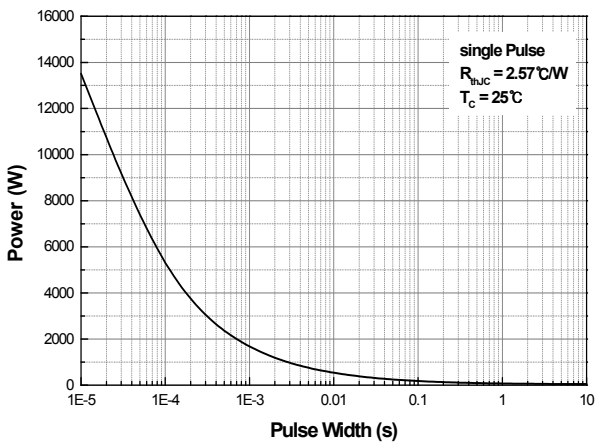


Fig.11 Single Pulse Maximum Power Dissipation

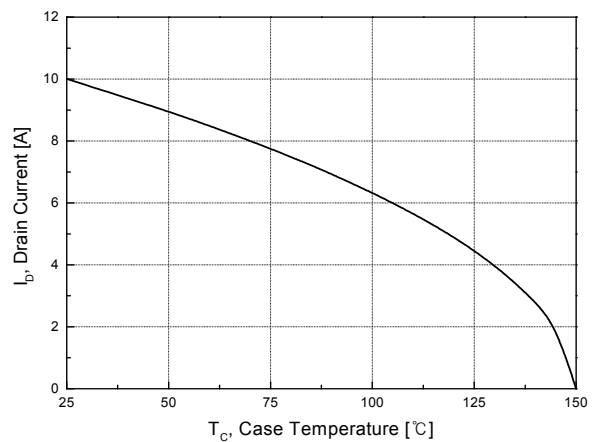
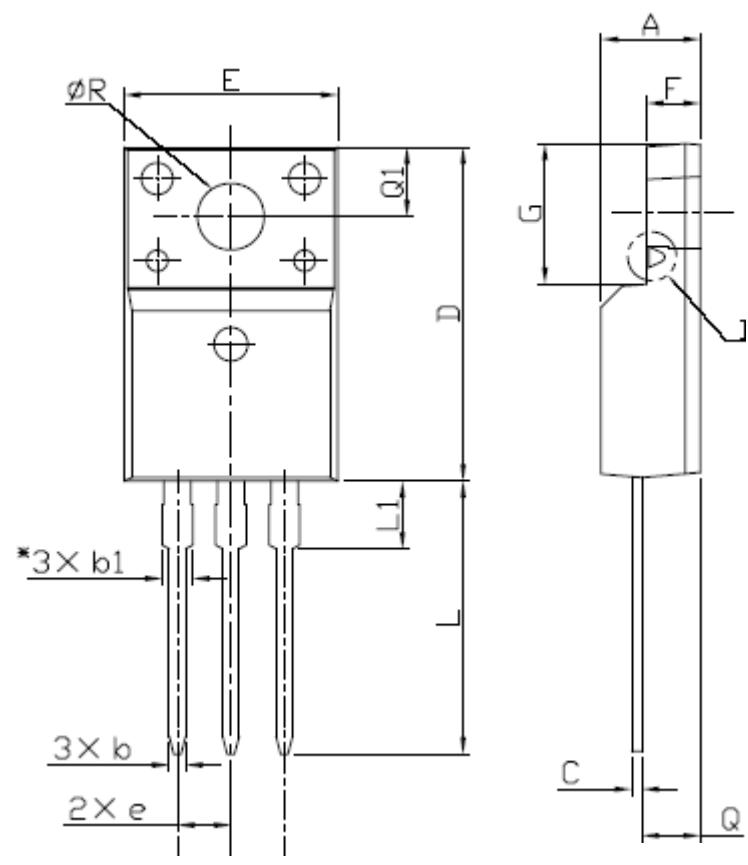


Fig.15 Maximum Drain Current vs. Case Temperature

Physical Dimensions

3 Leads, TO-220FS


Dimensions are in millimeters unless otherwise specified



| Symbol | Min | Nom | Max |
|----------|-------|------|-------|
| A | 4.50 | | 4.93 |
| b | 0.63 | | 0.91 |
| b1 | 1.15 | | 1.47 |
| C | 0.36 | | 0.63 |
| D | 15.47 | | 16.13 |
| E | 9.60 | | 10.71 |
| e | | 2.54 | |
| F | 2.34 | | 2.84 |
| G | 6.48 | | 6.90 |
| L | 12.37 | | 13.72 |
| L1 | 1.90 | | 2.30 |
| Q | 2.51 | | 2.96 |
| Q1 | 3.10 | | 3.50 |
| ϕR | 2.98 | | 3.38 |

DISCLAIMER:

The Products are not designed for use in hostile environments, including, without limitation, aircraft, nuclear power generation, medical appliances, and devices or systems in which malfunction of any Product can reasonably be expected to result in a personal injury. Seller's customers using or selling Seller's products for use in such applications do so at their own risk and agree to fully defend and indemnify Seller.

MagnaChip reserves the right to change the specifications and circuitry without notice at any time. MagnaChip does not consider responsibility for use of any circuitry other than circuitry entirely included in a MagnaChip product.  is a registered trademark of MagnaChip Semiconductor Ltd.